VS-SD1500C..L Series

Vishay Semiconductors

Standard Recovery Diodes, (Hockey PUK Version), 1600 A



B-PUK (DO-200AB)

PRIMARY CHARACTERISTICS					
I _{T(AV)} 1600 A					
Package	B-PUK (DO-200AB)				
Circuit configuration Single					

FEATURES

- Wide current range
- High voltage ratings up to 3000 V
- · High surge current capabilities
- Diffused junction
- Hockey PUK version
- Case style B-PUK (DO-200AB)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

- Converters
- Power supplies
- Machine tool controls
- High power drives
- Medium traction applications

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		1600	A			
I _{F(AV)}	T _{hs}	55	°C			
I _{F(RMS)}		3010	A			
	T _{hs}	25	°C			
1	50 Hz	16 600	Α			
I _{FSM}	60 Hz	17 400	A			
l ² t	50 Hz	1386	— kA ² s			
1-1	60 Hz	1265	KA-S			
V _{RRM}	Range	400 to 3000	V			
TJ		-40 to +180	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE R	ATINGS			
TYPE NUMBER	VOLTAGE CODE	V _{RRM} , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I _{RRM} MAXIMUM AT T _J = T _J MAXIMUM mA
	04	400	500	
	08	800	900	
	12	1200	1300	
VS-SD1500CL	16	1600	1700	50
	20	2000	2100	
	25	2500	2600	
	30	3000	3100	

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FORWARD CONDUCTION						
PARAMETER	SYMBOL	TEST CONDITIONS			VALUES	UNITS
Maximum average forward current	1	180° condu	180° conduction, half sine wave		1600 (820)	А
at heatsink temperature	I _{F(AV)}	Double side	e (single side) co	poled	55 (85)	°C
Maximum RMS forward current	I _{F(RMS)}	25 °C heats	sink temperatur	e double side cooled	3010	
		t = 10 ms	No voltage		16 600	A
Maximum peak, one cycle,	1	t = 8.3 ms	reapplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	17 400	
non-repetitive surge current	I _{FSM}	t = 10 ms	100 % V _{RRM}		14 000	
		t = 8.3 ms	reapplied		14 700	
	l ² t	t = 10 ms	No voltage		1386	kA ² s
Maximum I ² t for fusing		t = 8.3 ms	reapplied		1265	
Maximum 1-t for fusing		t = 10 ms	100 % V _{RRM}		980	
		t = 8.3 ms	reapplied		895	
Maximum I ² \sqrt{t} for fusing	l²√t	t = 0.1 to 10	0 ms, no voltage	e reapplied	13 860	kA²√s
Low level value of threshold voltage	V _{F(TO)1}	(16.7 % x π x $I_{F(AV)}$ < I < π x $I_{F(AV)}$), T _J = T _J maximum			0.83	V
High level value of threshold voltage	V _{F(TO)2}	$(I > \pi \times I_{F(AV)}), T_J = T_J maximum$			0.95	v
Low level value of forward slope resistance	r _{f1}	(16.7 % x π x $I_{F(AV)}$ < I < π x $I_{F(AV)}$), T _J = T _J maximum			0.27	mΩ
High level value of forward slope resistance	r _{f2}	$(I > \pi \times I_{F(AV)}), T_J = T_J$ maximum			0.25	11122
Maximum forward voltage drop	V _{FM}	$I_{pk} = 3000 \text{ A } T_J = T_J \text{ maximum},$ $t_p = 10 \text{ ms sinusoidal wave}$			1.64	V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction operating temperature range	TJ		-40 to 180	°C		
Maximum storage temperature range	T _{Stg}		-55 to 200	U		
Maximum thermal resistance,	R _{thJ-hs}	DC operation single side cooled	0.073	K/W		
junction to heatsink		DC operation double side cooled	0.031			
Mounting force, ± 10 %			14 700 (1500)	N (kg)		
Approximate weight			255	g		
Case style		See dimensions - link at the end of datasheet	B-PUK (DO-200AB)			

CONDUCTION ANGLE	SINUSOIDAL	CONDUCTION	RECTANGULAR	R CONDUCTION	TEST CONDITIONS	UNITS	
CONDUCTION ANGLE	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE	TEST CONDITIONS	UNITS	
180°	0.009	0.009	0.006	0.006			
120°	0.011	0.011	0.011	0.011			
90°	0.014	0.014	0.015	0.015	$T_J = T_J$ maximum	K/W	
60°	0.020	0.020	0.021	0.021			
30°	0.035	0.035	0.036	0.036			

Note

• The table above shows the increment of thermal resistance R_{thJ-hs} when devices operate at different conduction angles than DC



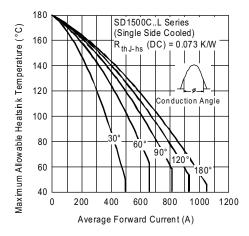


Fig. 1 - Current Ratings Characteristics

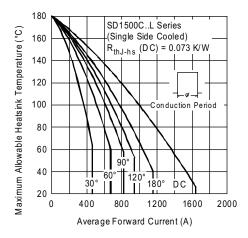


Fig. 2 - Current Ratings Characteristics

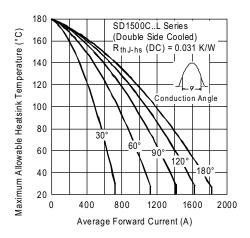


Fig. 3 - Current Ratings Characteristics

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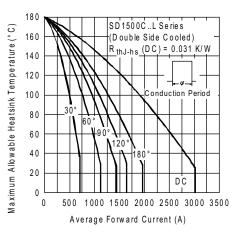


Fig. 4 - Current Ratings Characteristics

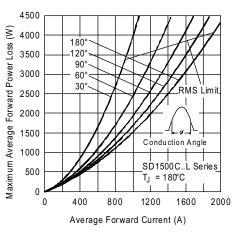


Fig. 5 - Forward Power Loss Characteristics

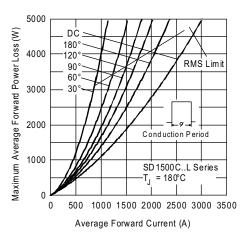


Fig. 6 - Forward Power Loss Characteristics

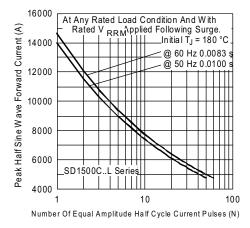
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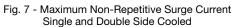
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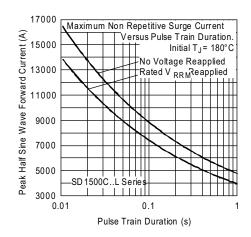


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

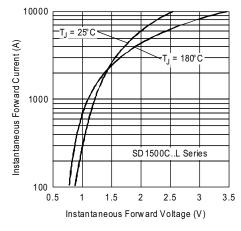


Fig. 9 - Forward Voltage Drop Characteristics

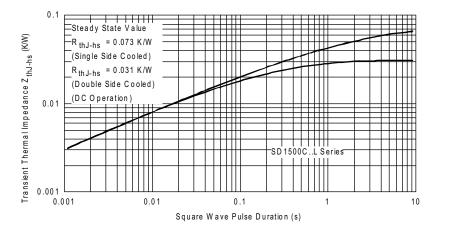


Fig. 10 - Thermal Impedance Z_{thJC} Characteristics

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ORDERING INFORMATION TABLE

Device code	VS-	SD	150	0	С	30	L	
		2	3	4	5	6	7	
	1 -	- Vishay Semiconductors product						
	2 -	2 - Diode						
	3 -	- Essential part number						
	4 -	- 0 = standard recovery						
	5 -	- C = ceramic PUK						
	6 -	- Voltage code x 100 = V _{RRM} (see Voltage Ratings table)						
	7 -	- L = PUK case B-PUK (DO-200AB)						

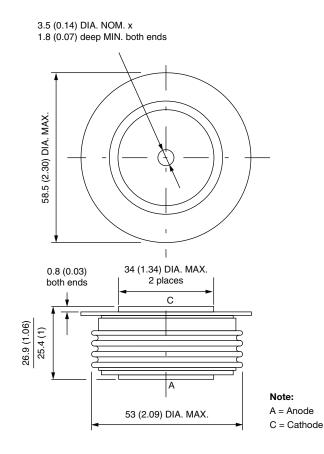
LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95246			





B-PUK (DO-200AB)

DIMENSIONS in millimeters (inches)



Quote between upper and lower pole pieces has to be considered after application of mounting force (see Thermal and Mechanical Specifications)



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